



SIGPRO

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News Release

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Ottawa's SIGPRO Wireless Front and Center in the European 3G Wireless Mobility Market

Flexium™ Launched in Europe

Ottawa, Ontario, Canada - 1 Jun 2002 - SIGPRO Wireless an Ottawa based Wireless Mobility Company is emerging front and center in the European 3G wireless mobility industry. After two years in research and development for a System on Chip solution for the wireless mobility market, SIGPRO successfully introduced their flagship product; the Flexium™ chip to industry leading 3G mobile phone manufacturers and major global 3G mobile infrastructure suppliers based in Europe.

SIGPRO's breakthrough architecture was first introduced to the European market at the seventh annual Canada Sweden Business Association (CSBA) event in Stockholm, Sweden on the 16th of May. SIGPRO's CEO Dr. Sundara Murthy joined a panel of industry visionaries including Chris Bannister the CEO of Hi3G and Bernt Ericson the Vice President of Ericsson Foresight at the CSBA event to introduce The Flexium™ chip as a breakthrough architecture for 3G mobile phones. SIGPRO Wireless also joined Canada's 3G-trade mission in Stockholm, Sweden on the 17th of May, which enabled SIGPRO to introduce the Flexium™ chip to mobile handset manufacturers, wireless infrastructure suppliers and Wireless Service Providers. The European product launch also included site visits to clients who previously expressed interest in the Flexium™ chip. "We had an extremely busy week in Europe, we introduced our architecture to clients in different European countries and are pleased to announce that SIGPRO Wireless has signed a Memorandum of Understanding with one of Europe's leading mobile phone manufacturers. They will be evaluating our System on Chip solutions for their next generation of mobile phones" explained Dr. Sundara Murthy. "This is just the tip of the iceberg for SIGPRO Wireless."

Founded in May 2000 by Dr. Sundara Murthy. SIGPRO Wireless is engaged in the development of critical System-on-Chip (SoC) and associated software solutions for next-generation wireless mobility Personal Communication Devices (PCDs). With a pioneering architecture, SIGPRO's programmable Flexium™ chip supports a variety of worldwide standards, data rates, protocols, services and applications. With Flexium™ inside, the next generation wireless PCD will "empower the individual" with a multitude of personal communication (cellular phones), computation (palm computers), information (email, web devices), navigation (GPS), and entertainment (MPEG4, MP3) services. Flexium™ is leading the technology "Convergence" in PCDs to deliver "All-in-one" integrated services to people on the move.

For more information about SIGPRO Wireless and the Flexium™ chips visit www.sigprowireless.com